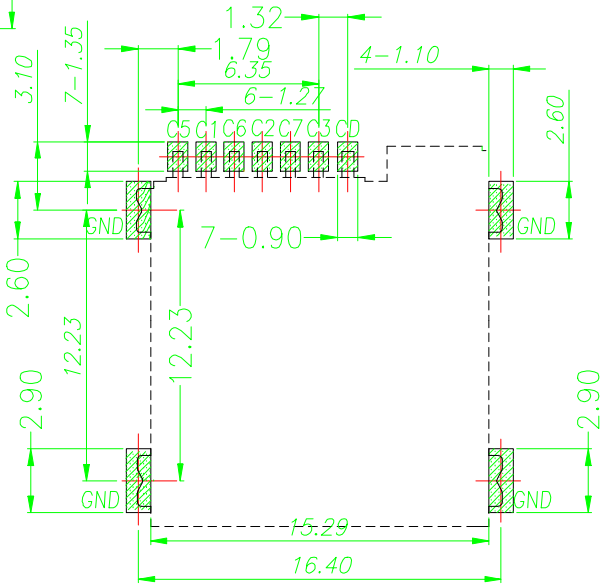
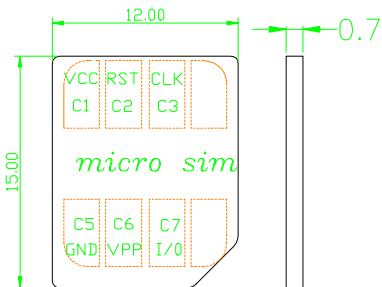
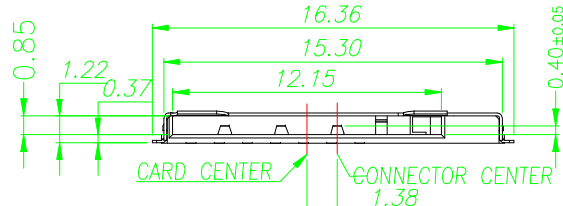
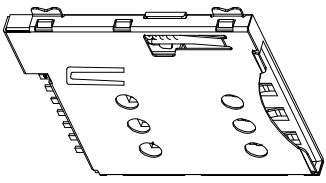
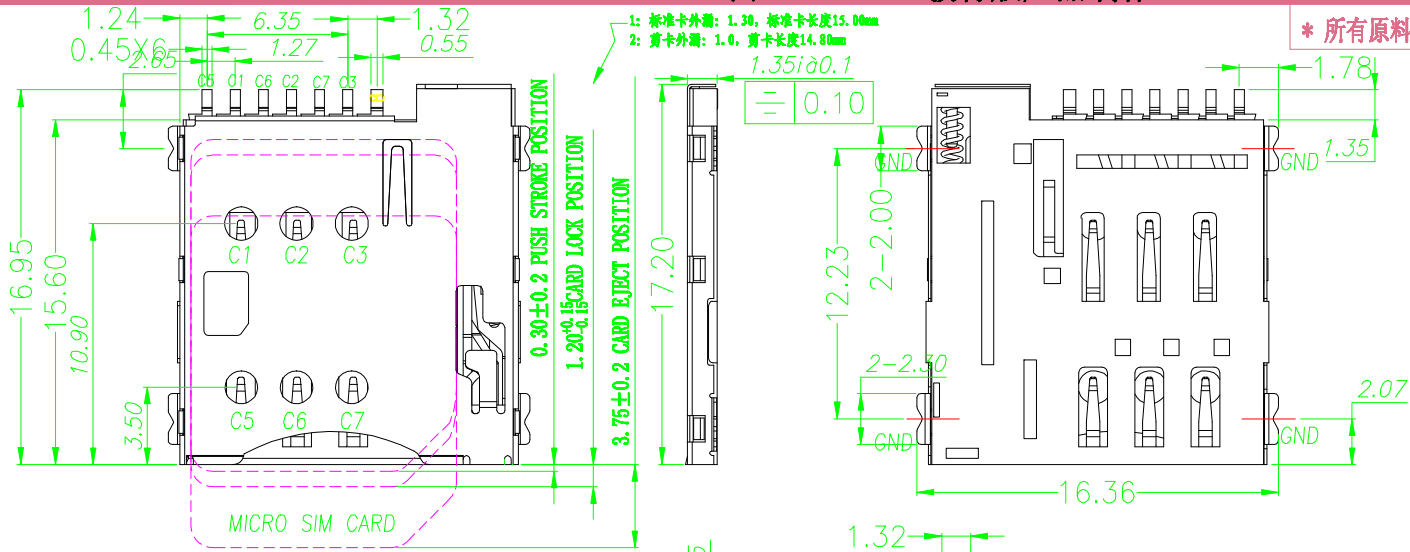


\* 所有原材料, 生产制程, 电镀必须符合ROHS要求



Specification

**MATERIAL:**  
 Insulator: High Temperature Thermoplastic, UL 94V-0.  
 Contact: Copper Alloy  
 SHELL: SUS

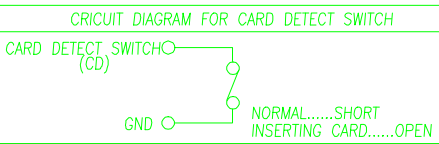
**PLATING:**  
 Contact: Plated 50μ" Ni Overall Contact Au 1U  
 Shell: Plated 50μ" Ni Overall  
 Plated InAu Selective Contact Area

**Electrical:**  
 Current Rating :0.5mA AC/DC max.  
 Voltage Rating :125V AC/DC  
 Ambient Temperature Range :-20° C~+60° C  
 Storage Temperature Range :-40° C~+70° C  
 Ambient Humidity Range :95% R.H. Max.  
 Contact Resistance:100m Ω max.  
 Insulation Resistance:1000M Ω min./500VDC  
 产品耐温温度: 260° C DR:SL:TD:DC:SL:TD:HD:DC  
 Mating Cycles:3000Min Insertions

SIM pin assignment	PIN#	Name
	C1	VCC供电电压
	C2	RST重置
	C3	CLK时钟
	C5	GND接地
	C6	VPP程序电压
	C7	I/O输入输出

PCB 焊盘区  
 下流灌位区

RECOMMENDED PCB LAYOUT  
 GENERAL TOLERANCE ±0.05



REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				
2				



深圳市连欣科技有限公司

DIMENSIONS INTY: mm  
 UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
L I: ±	0.15
L II: ±	0.10
L III: ±	0.05
ANGULAR: ±	1°

PRODUCT NAME: MICRO-SIM 卡座PUSH/PUSH 1.35H 带CD PIN B版	DRAWING: 叶洽谋	DATE: 2017/12/22
PRODUCT NO.: XDSM-0620-0512B	CHECK: JANY	DATE: 2017/12/22
DRAWING NO.: LXSIM-00121AA017B	APPROVING: 陈永清	DATE: 2017/12/22
SCALE: 1:1	REV. ID: C D	REV.: B
		PAGE: 1 of 1